

MOSFET

OptiMOS™ 5 Power-Transistor, 150 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

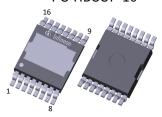
Product validation

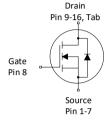
Fully qualified according to JEDEC for Industrial Applications

Table 1 Key Performance Parameters

Parameter	Value	Unit					
$V_{ m DS}$	150	V					
R _{DS(on),max}	3.9	mΩ					
I _D	190	А					
Q _{oss}	207	nC					
Q_{G}	74	nC					











Type/Ordering Code	Package	Marking	Related Links
IPTC039N15NM5	PG-HDSOP-16	039N15N5	-

Public

OptiMOS™ 5 Power-Transistor, 150 V IPTC039N15NM5



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OptiMOS™ 5 Power-Transistor, 150 V IPTC039N15NM5



1 Maximum ratings

unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Note / Took Condition	
raiailletei	Syllibot	Min.	Тур.	Мах.		Note/ Test Condition	
Continuous drain current ¹⁾	I _D	-	-	190 134 128 21	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =40°C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	760	А	T _A =25 °C	
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	344	mJ	$I_{\rm D}$ =100 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V_{GS}	-20	-	20	V	-	
Power dissipation	P_{tot}	-	-	319 3.8	w	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W ²⁾	
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-55	-	175	°C	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note/ Test Condition
raianietei	Syllibot	Min.	Тур.	Мах.	Offic	Note/ Test Condition
Thermal resistance, junction - case	R_{thJC}	-	-	0.47	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area ⁵⁾	R_{thJA}	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimum footprint	R_{thJA}	-	-	62	°C/W	-

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics

unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note / Tost Condition	
raiailletei	Syllibot	Min.	Тур.	Мах.	Oilit	Note/ Test Condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	150	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.8	4.6	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 243 \mu \text{A}$	
Zero gate voltage drain current	I_{DSS}	-	0.1 10	1.0 100	μΑ	$V_{\rm DS}$ =120 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =120 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C	
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	$R_{\mathrm{DS(on)}}$	-	3.5 3.8	3.9 4.3	mΩ	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A $V_{\rm GS}$ =8 V, $I_{\rm D}$ =25 A	
Gate resistance ⁶⁾	R_{G}	-	1.1	1.6	Ω	-	
Transconductance	g_{fs}	-	110	-	S	$ V_{\rm DS} \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 50 \text{ A}$	

⁶⁾ Defined by design. Not subject to production test.

Table 5 Dynamic characteristics

Darameter	Symbol	Values			Unit	Nieto/Test Condition	
Parameter	Syllibol	Min.	Тур.	Мах.		Note/ Test Condition	
Input capacitance 7)	C _{iss}	-	5600	7300	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =75 V, f =1 MHz	
Output capacitance 7)	$C_{\rm oss}$	-	1400	1930	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz	
Reverse transfer capacitance ⁷⁾	C _{rss}	-	31	55	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =75 V, f =1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	19	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.	
Rise time	t _r	-	4.5	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.	
Turn-off delay time	$t_{\sf d(off)}$	-	23.5	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.	
Fall time	t _f	-	5.5	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.	

 $^{^{7)}}$ Defined by design. Not subject to production test.

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Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Note/ Test Condition
	Symbol	Min.	Тур.	Max.	Offic	Note/ Test condition
Gate to source charge	$Q_{\rm gs}$	-	30	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	21	-	nC	V_{DD} =75 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate to drain charge ⁹⁾	Q_{gd}	-	15	22	nC	V_{DD} =75 V, I_{D} =50 A, V_{GS} =0 to 10 V
Switching charge	Q_{sw}	-	23	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ⁹⁾	$Q_{ m g}$	-	74	93	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	$V_{ m plateau}$	-	5.4	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Output charge ⁹⁾	Q _{oss}	-	207	275	nC	V _{DS} =75 V, V _{GS} =0 V

⁸⁾ See "Gate charge waveforms" for parameter definition

Table 7 Reverse diode

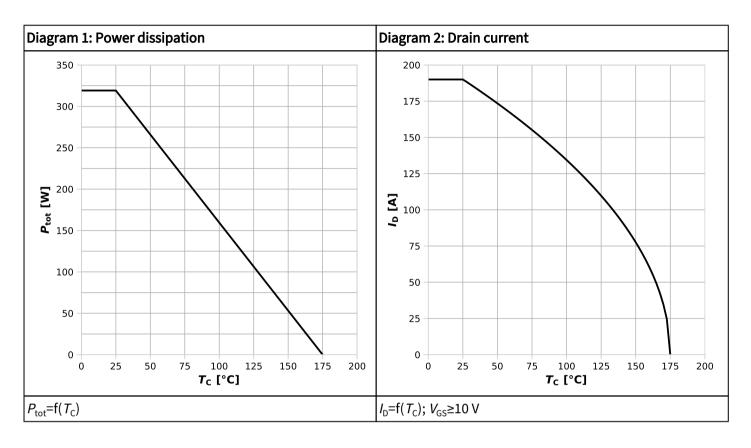
Parameter	Symbol	Values			Unit	Note/ Test Condition	
Parameter	Syllibol	Min.	Тур.	Мах.	Ollic		
Diode continuous forward current	I_{S}	-	-	190	А	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	760	А	<i>T</i> _c =25 °C	
Diode forward voltage	$V_{\rm SD}$	-	0.81	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =50 A, $T_{\rm j}$ =25 °C	
Reverse recovery time ¹⁰⁾	$t_{\rm rr}$	-	53.5	107	ns	$V_{\rm R}$ =75 V, $I_{\rm F}$ =50 A, d $i_{\rm F}$ /d t =100 A/ μ s	
Reverse recovery charge ¹⁰⁾	$Q_{\rm rr}$	-	77	155	nC	$V_{\rm R}$ =75 V, $I_{\rm F}$ =50 A, d $i_{\rm F}$ /d t =100 A/ μ s	

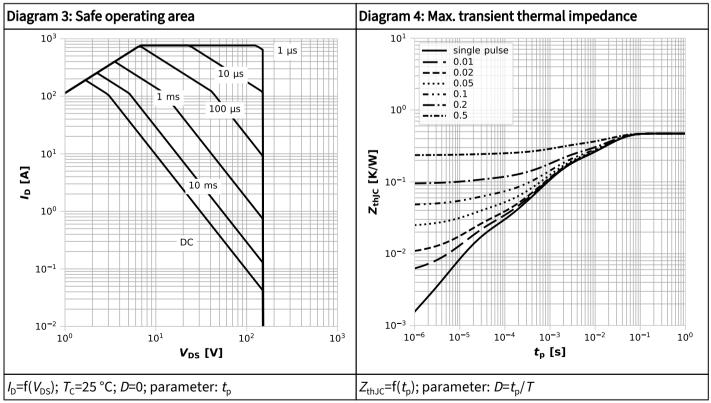
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⁹⁾ Defined by design. Not subject to production test.

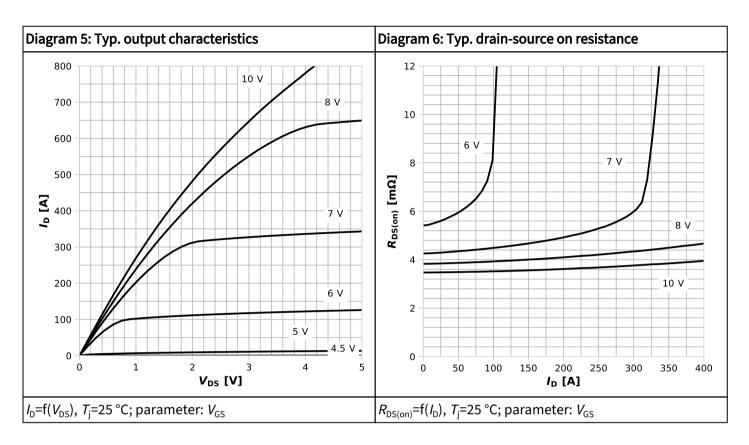


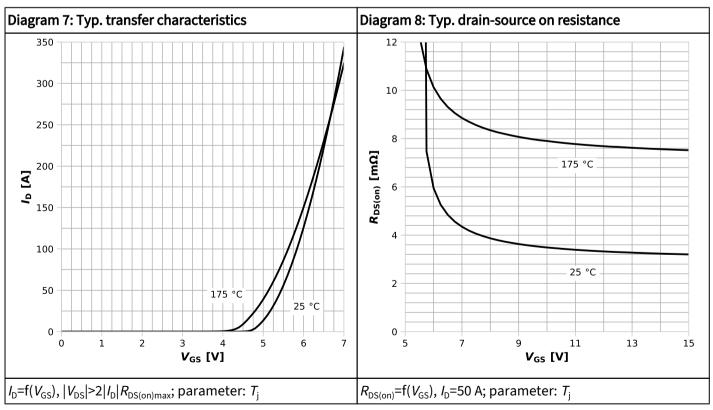
4 Electrical characteristics diagrams



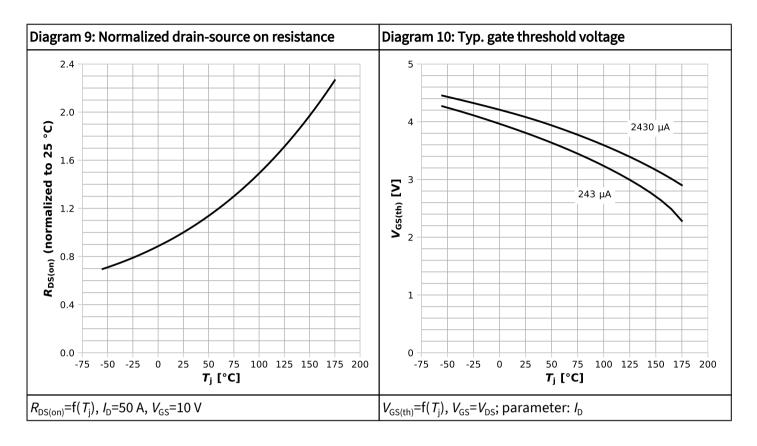


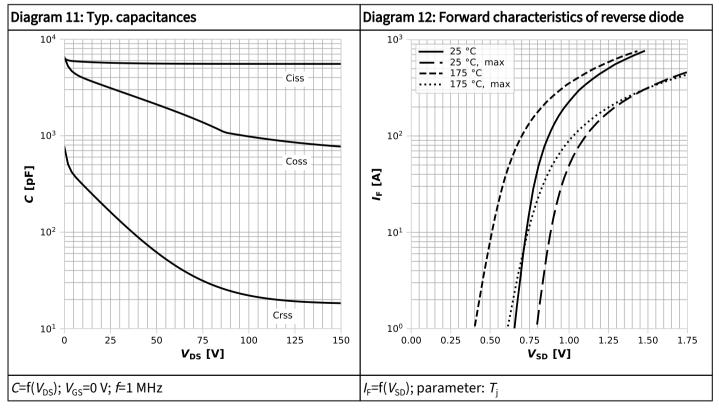




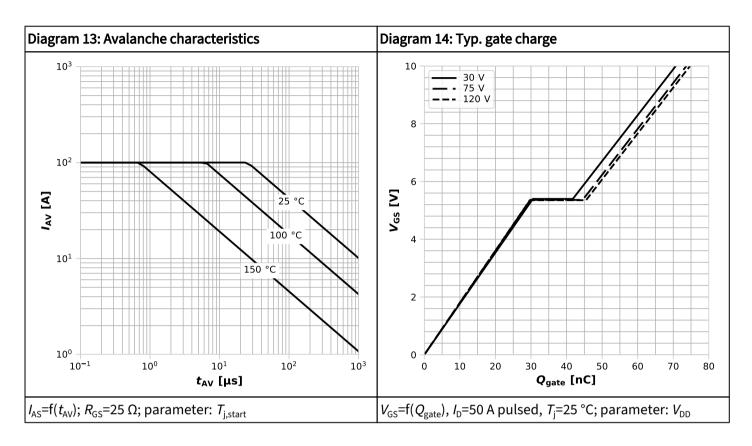


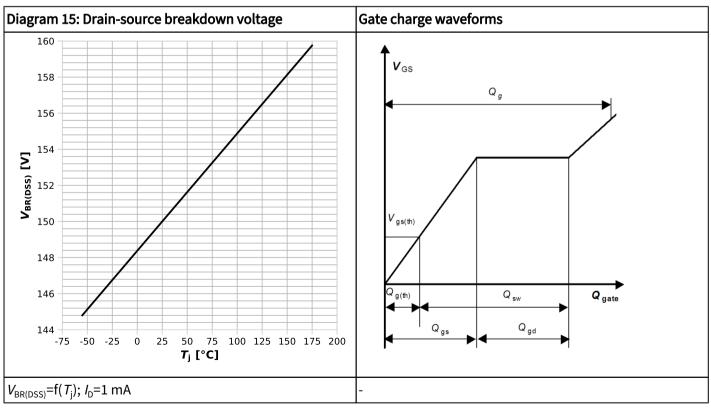














5 Package Outlines

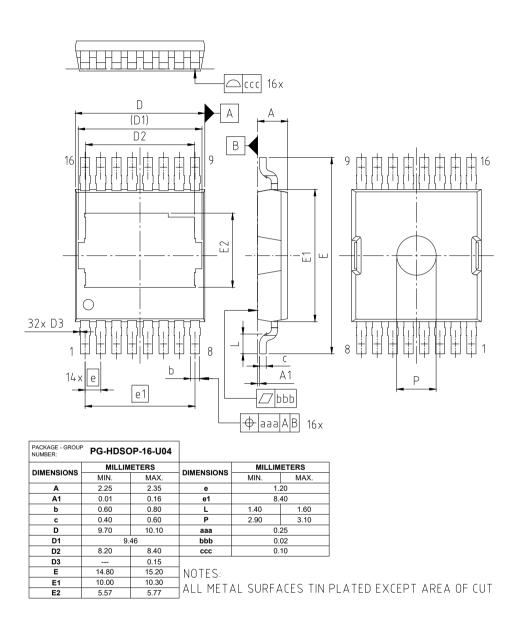


Figure 1 Outline PG-HDSOP-16, dimensions in mm



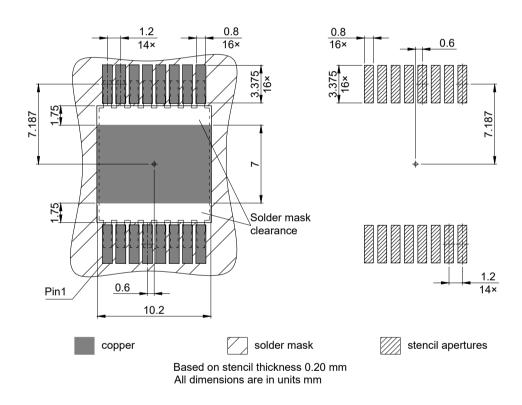
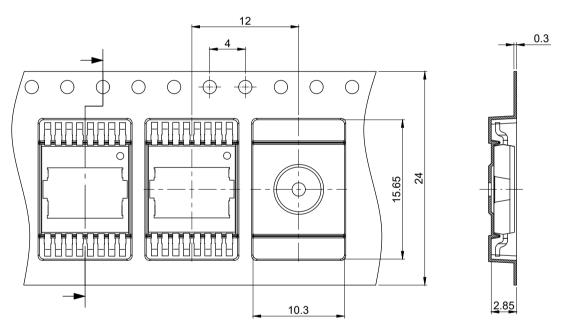


Figure 2 Outline PG-HDSOP-16, dimensions in mm





All dimensions are in units mm

The drawing is in compliance with ISO 128-30, Projection Method 1 [

Figure 3 Outline PG-HDSOP-16, dimensions in mm

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Revision History

IPTC039N15NM5

Revision 2024-06-11, Rev. 2.2

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2022-05-05	Release of final version
2.1	2023-03-08	Update Coss max
2.2	2024-06-11	Update Rg

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